Renesas Electronics America Inc - UPD78F0475GK-GAK-AX Datasheet

Welcome to E-XFL.COM

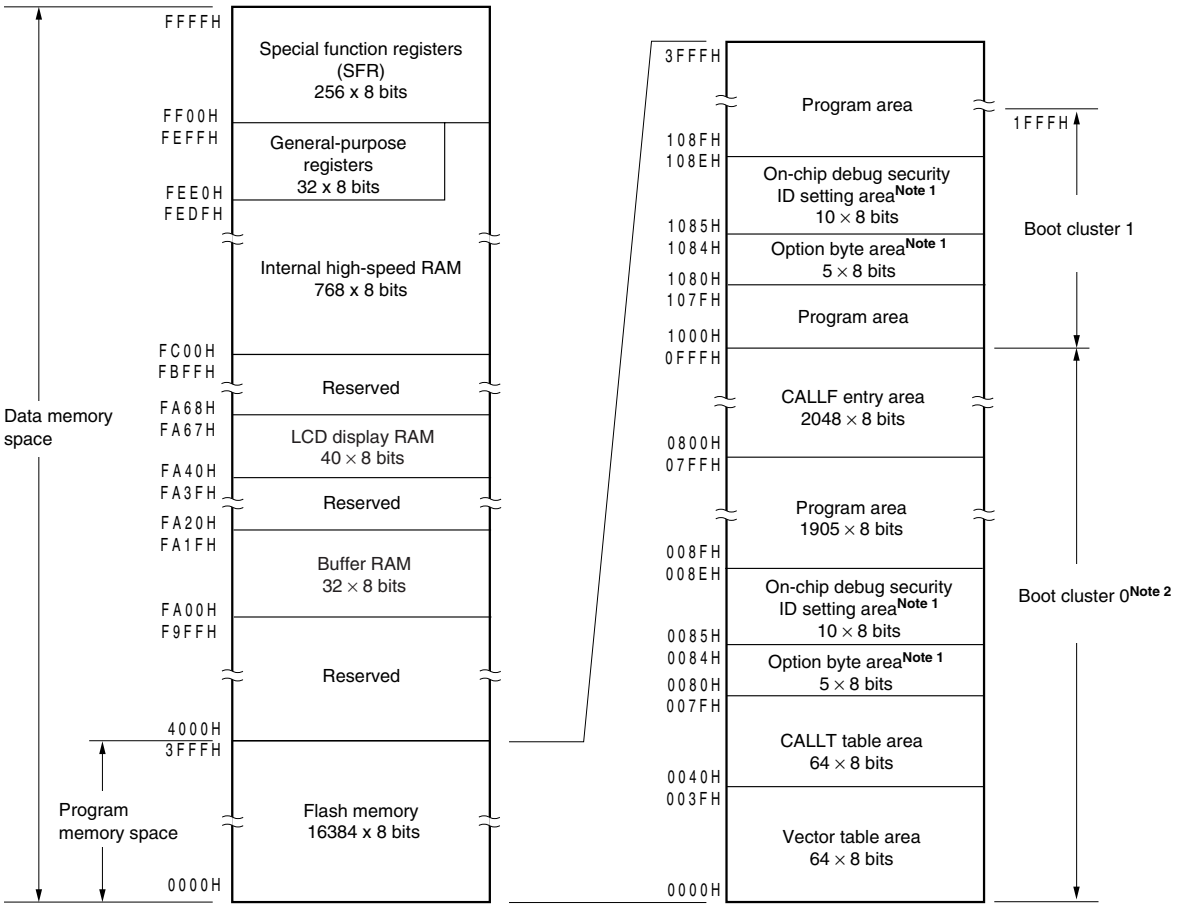
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	78K/0
Core Size	8-Bit
Speed	10MHz
Connectivity	3-Wire SIO, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	62
Program Memory Size	60KB (60K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/upd78f0475gk-gak-ax

Figure 3-1. Memory Map (μPD78F0471, 78F0481)

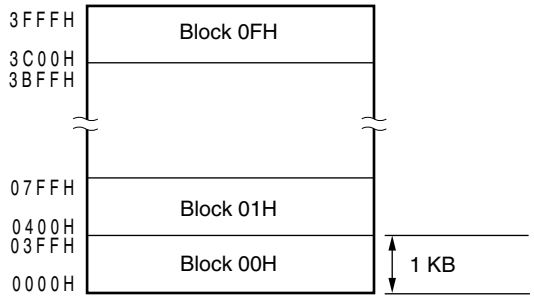


Notes 1. When boot swap is not used: Set the option bytes to 0080H to 0084H, and the on-chip debug security IDs to 0085H to 008EH.

When boot swap is used: Set the option bytes to 0080H to 0084H and 1080H to 1084H, and the on-chip debug security IDs to 0085H to 008EH and 1085H to 108EH.

2. Writing boot cluster 0 can be prohibited depending on the setting of security (see **28.8 Security Setting**).

Remark The flash memory is divided into blocks (one block = 1 KB). For the address values and block numbers, see **Table 3-2 Correspondence Between Address Values and Block Numbers in Flash Memory**.



5.4 System Clock Oscillator

5.4.1 X1 oscillator

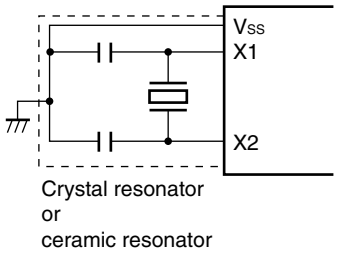
The X1 oscillator oscillates with a crystal resonator or ceramic resonator (2 to 10 MHz) connected to the X1 and X2 pins.

An external clock can also be input. In this case, input the clock signal to the EXCLK pin.

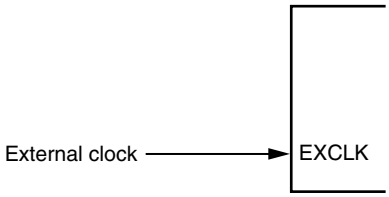
Figure 5-10 shows an example of the external circuit of the X1 oscillator.

Figure 5-10. Example of External Circuit of X1 Oscillator

(a) Crystal or ceramic oscillation



(b) External clock



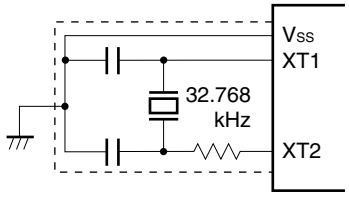
5.4.2 XT1 oscillator

The XT1 oscillator oscillates with a crystal resonator (standard: 32.768 kHz) connected to the XT1 and XT2 pins.

Figure 5-11 shows an example of the external circuit of the XT1 oscillator.

Figure 5-11. Example of External Circuit of XT1 Oscillator

(a) Crystal oscillation



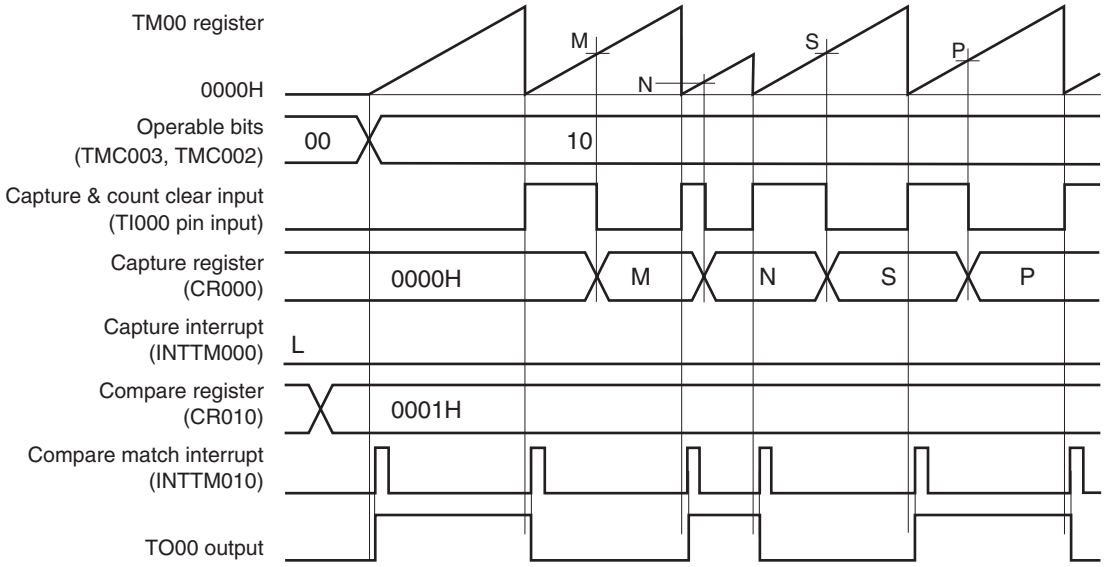
Caution 1. When using the X1 oscillator and XT1 oscillator, wire as follows in the area enclosed by the broken lines in the Figures 5-10 and 5-11 to avoid an adverse effect from wiring capacitance.

- **Keep the wiring length as short as possible.**
- **Do not cross the wiring with the other signal lines. Do not route the wiring near a signal line through which a high fluctuating current flows.**
- **Always make the ground point of the oscillator capacitor the same potential as Vss. Do not ground the capacitor to a ground pattern through which a high current flows.**
- **Do not fetch signals from the oscillator.**

Note that the XT1 oscillator is designed as a low-amplitude circuit for reducing power consumption.

Figure 6-28. Timing Example of Clear & Start Mode Entered by TI000 Pin Valid Edge Input (CR000: Capture Register, CR010: Compare Register) (1/2)

(a) TOC00 = 13H, PRM00 = 10H, CRC00, = 03H, TMC00 = 08H, CR010 = 0001H



This is an application example where the TO00 output level is to be inverted when the count value has been captured & cleared.

TM00 is cleared at the rising edge detection of the TI000 pin and it is captured to CR000 at the falling edge detection of the TI000 pin.

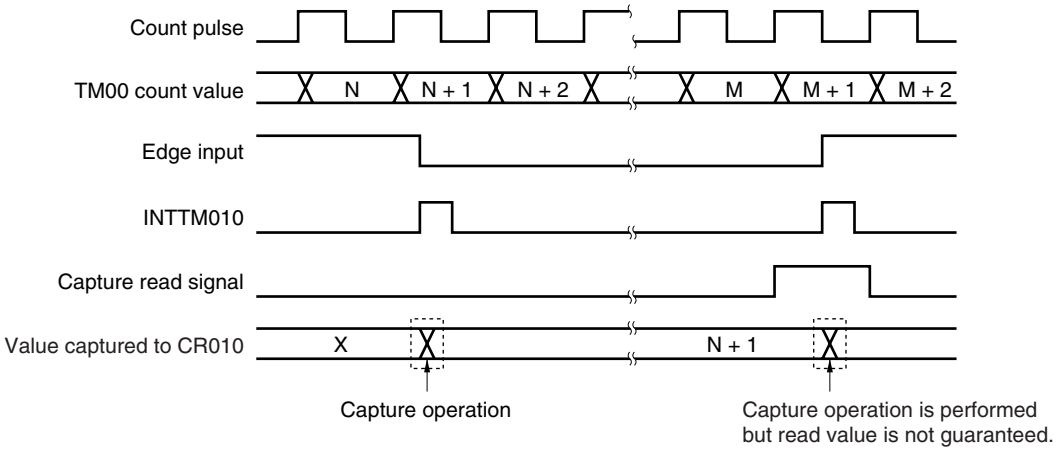
When bit 1 (CRC001) of capture/compare control register 00 (CRC00) is set to 1, the count value of TM00 is captured to CR000 in the phase reverse to that of the signal input to the TI000 pin, but the capture interrupt signal (INTTM000) is not generated. However, the INTTM000 signal is generated when the valid edge of the TI010 pin is detected. Mask the INTTM000 signal when it is not used.

(4) Timing of holding data by capture register

(a) When the valid edge is input to the TI000/TI010 pin and the reverse phase of the TI000 pin is detected while CR000/CR010 is read, CR010 performs a capture operation but the read value of CR000/CR010 is not guaranteed. At this time, an interrupt signal (INTTM000/INTTM010) is generated when the valid edge of the TI000/TI010 pin is detected (the interrupt signal is not generated when the reverse-phase edge of the TI000 pin is detected).

When the count value is captured because the valid edge of the TI000/TI010 pin was detected, read the value of CR000/CR010 after INTTM000/INTTM010 is generated.

Figure 6-60. Timing of Holding Data by Capture Register



(b) The values of CR000 and CR010 are not guaranteed after 16-bit timer/event counter 00 stops.

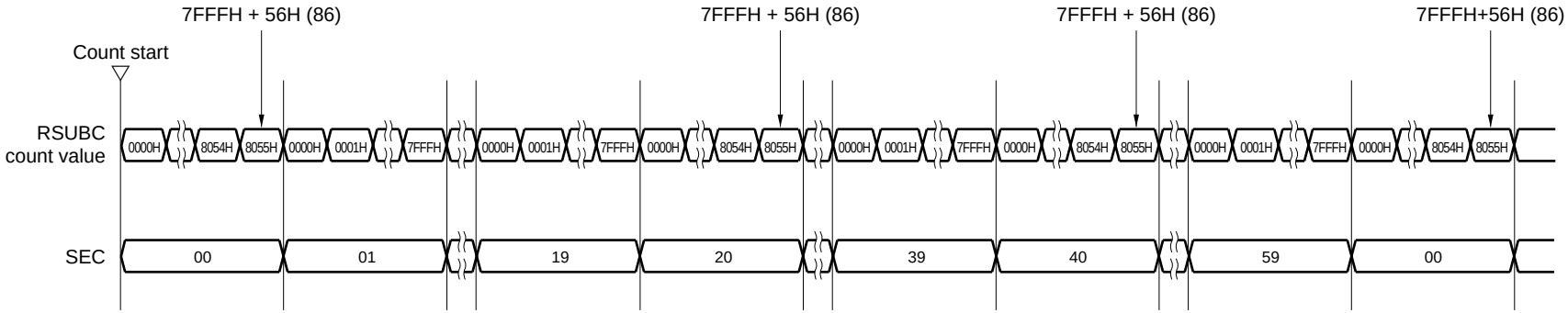
(5) Setting valid edge

Set the valid edge of the TI000 pin while the timer operation is stopped (TMC003 and TMC002 = 00). Set the valid edge by using ES000 and ES001.

(6) Re-triggering one-shot pulse

Make sure that the trigger is not generated while an active level is being output in the one-shot pulse output mode. Be sure to input the next trigger after the current active level is output.

Figure 9-26. Operation when (DEV, F6, F5, F4, F3, F2, F1, F0) = (0, 0, 1, 0, 1, 1, 0, 0)



(6) Port mode register 2 (PM2)

When using the ANI0/P20 to ANI7/P27 pins for analog input port, set PM20 to PM27 to 1. The output latches of P20 to P27 at this time may be 0 or 1.

If PM20 to PM27 are set to 0, they cannot be used as analog input port pins.

PM2 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to FFH.

Figure 12-10. Format of Port Mode Register 2 (PM2)

Address: FF22H After reset: FFH R/W

Symbol	7	6	5	4	3	2	1	0
PM2	PM27	PM26	PM25	PM24	PM23	PM22	PM21	PM20

PM2n	P2n pin I/O mode selection (n = 0 to 7)
0	Output mode (output buffer on)
1	Input mode (output buffer off)

ANI0/P20 to ANI7/P27 pins are as shown below depending on the settings of PF2, ADPC0, PM2, ADS, and ADDCTL0.

Table 12-3. Setting Functions of P20/ANI0 to P27/ANI7 Pins

(a) μPD78F048x

PF2	ADPC0	PM2	ADS	P20/SEG39/ANI0 to P27/SEG32/ANI7 Pins
Digital/Analog selection	Analog input selection	Input mode	Does not select ANI.	Analog input (not to be converted)
			Selects ANI.	Analog input (to be converted by successive approximation type A/D converter)
		Output mode	–	Setting prohibited
	Digital I/O selection	Input mode	–	Digital input
		Output mode	–	Digital output
SEG output selection	–	–	–	Segment output

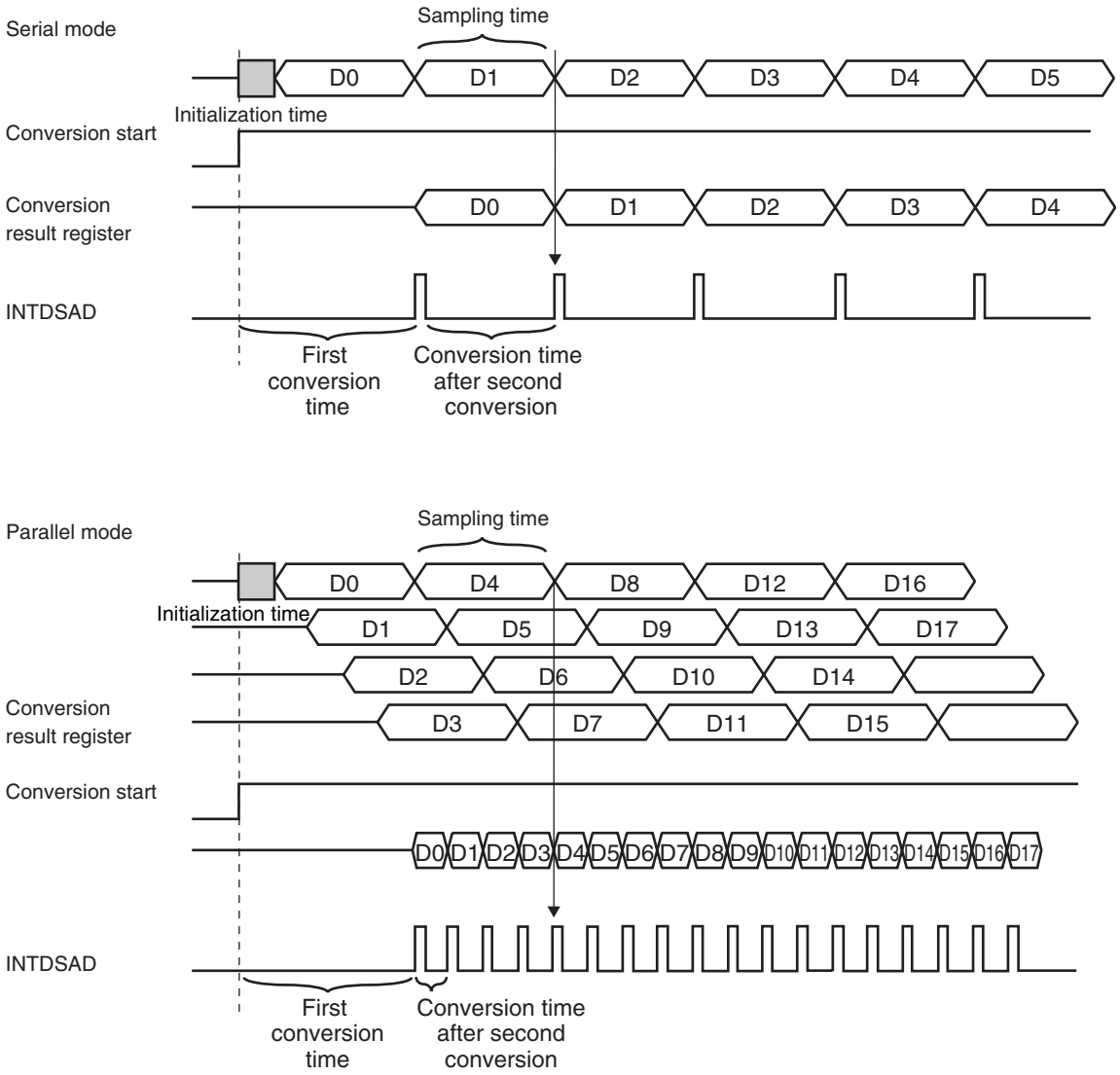
(b) μPD78F049x

ADPC0	PM2	ADS	ADDCTL0	P20/ANI0/DS0- to P27/ANI7/REF+ Pins
Analog input selection	Input mode	Does not select ANI.	Does not select DSn±.	Analog input (not to be converted)
		Selects ANI.	Does not select DSn±.	Analog input (to be converted by successive approximation type A/D converter)
		Does not select ANI.	Selects DSn±.	Analog input (to be converted by ΔΣ type A/D converter)
		Selects ANI.	Selects DSn±.	Setting prohibited
	Output mode	–		Setting prohibited
Digital I/O selection	Input mode	–		Digital input
	Output mode	–		Digital output

(3) Serial mode/parallel mode

Serial or parallel mode can be selected as the input mode for the 16-bit ΔΣ type A/D converter. The parallel mode can reduce the conversion time to a fourth of that in the serial mode. The conversion time of the first conversion, however, is the same as that in the serial mode. Also, the sampling time itself is the same as in the serial mode.

Figure 13-14. Conversion Time and Sampling Time



(d) Reception

Reception is enabled and the RxD0 pin input is sampled when bit 7 (POWER0) of asynchronous serial interface operation mode register 0 (ASIM0) is set to 1 and then bit 5 (RXE0) of ASIM0 is set to 1.

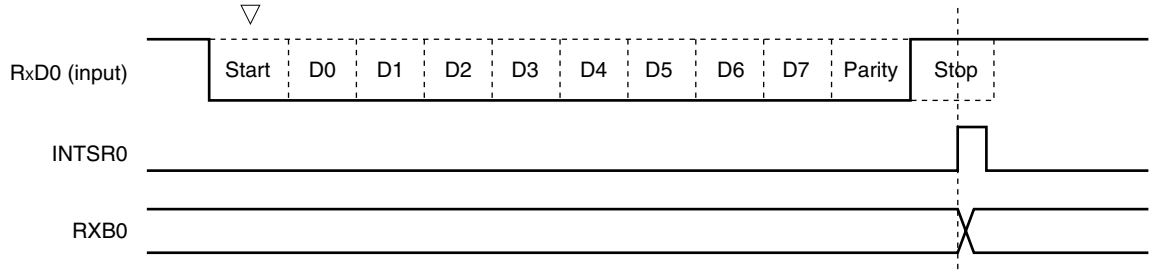
The 5-bit counter of the baud rate generator starts counting when the falling edge of the RxD0 pin input is detected. When the set value of baud rate generator control register 0 (BRGC0) has been counted, the RxD0 pin input is sampled again (▽in Figure 14-10). If the RxD0 pin is low level at this time, it is recognized as a start bit.

When the start bit is detected, reception is started, and serial data is sequentially stored in receive shift register 0 (RXS0) at the set baud rate. When the stop bit has been received, the reception completion interrupt (INTSR0) is generated and the data of RXS0 is written to receive buffer register 0 (RXB0). If an overrun error (OVE0) occurs, however, the receive data is not written to RXB0.

Even if a parity error (PE0) occurs while reception is in progress, reception continues to the reception position of the stop bit, and an reception error interrupt (INTSR0) is generated after completion of reception.

INTSR0 occurs upon completion of reception and in case of a reception error.

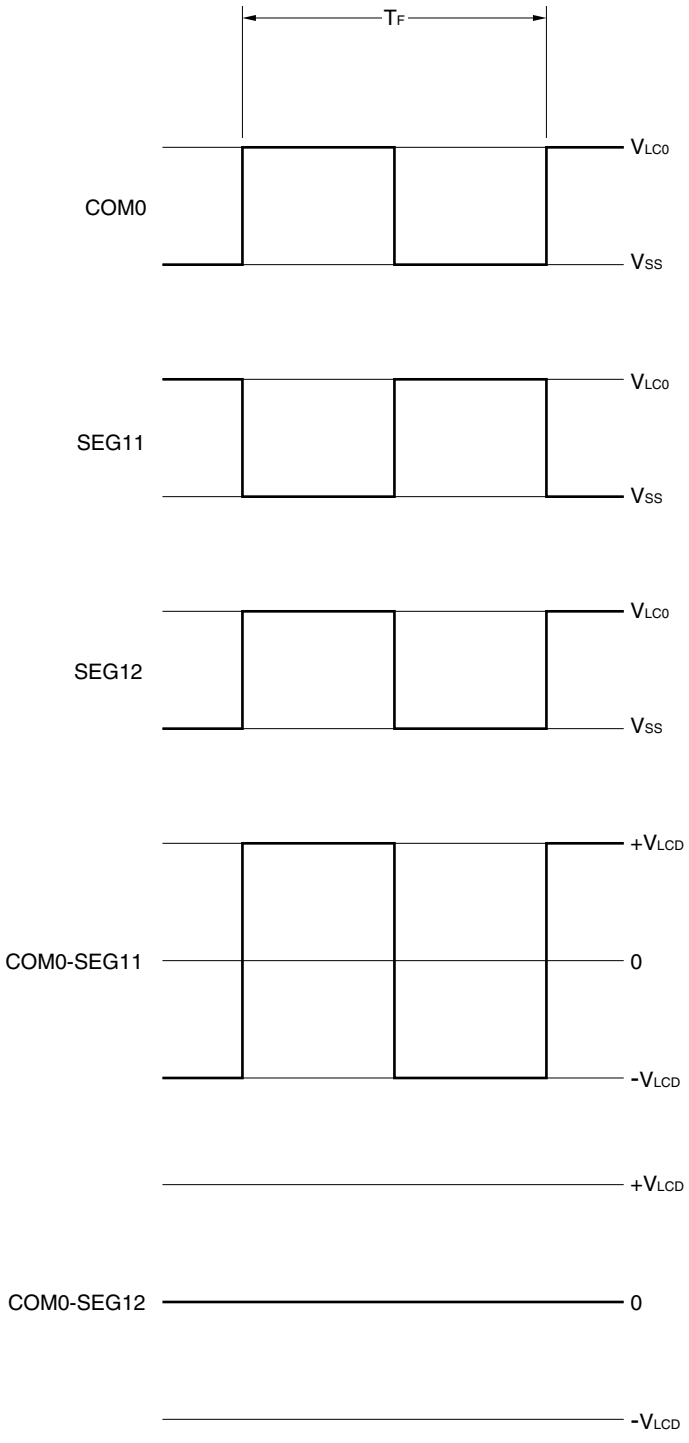
Figure 14-10. Reception Completion Interrupt Request Timing



Cautions 1. If a reception error occurs, read asynchronous serial interface reception error status register 0 (ASIS0) and then read receive buffer register 0 (RXB0) to clear the error flag. Otherwise, an overrun error will occur when the next data is received, and the reception error status will persist.

2. Reception is always performed with the "number of stop bits = 1". The second stop bit is ignored.

Figure 18-19. Static LCD Drive Waveform Examples



18.7.3 Three-time-slice display example

Figure 18-24 shows how the 8-digit LCD panel having the display pattern shown in Figure 18-23 is connected to the segment signals (SEG0 to SEG23) and the common signals (COM0 to COM2) of the 78K0/LF3 chip. This example displays data "123456.78" in the LCD panel. The contents of the display data memory (addresses FA40H to FA57H) correspond to this display.

The following description focuses on numeral "6." (6.) displayed in the third digit. To display "6." in the LCD panel, it is necessary to apply the select or deselect voltage to the SEG6 to SEG8 pins according to Table 18-8 at the timing of the common signals COM0 to COM2; see Figure 18-23 for the relationship between the segment signals and LCD segments.

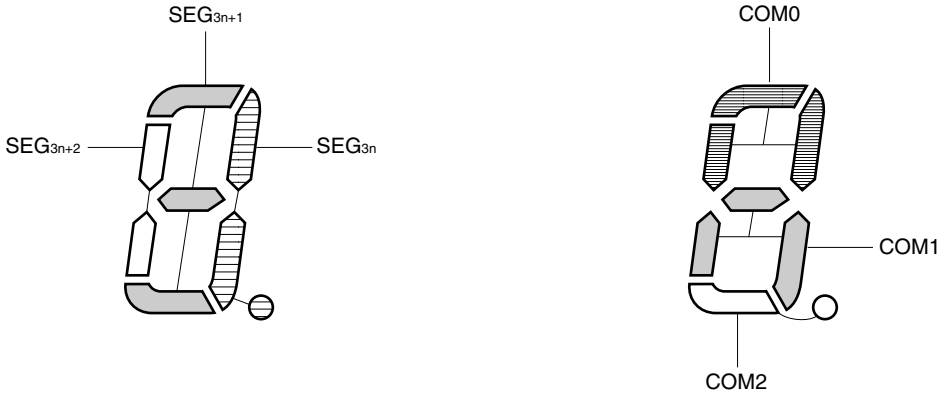
Table 18-8. Select and Deselect Voltages (COM0 to COM2)

Segment / Common	SEG6	SEG7	SEG8
COM0	Deselect	Select	Select
COM1	Select	Select	Select
COM2	Select	Select	–

According to Table 18-8, it is determined that the display data memory location (FA46H) that corresponds to SEG6 must contain x110.

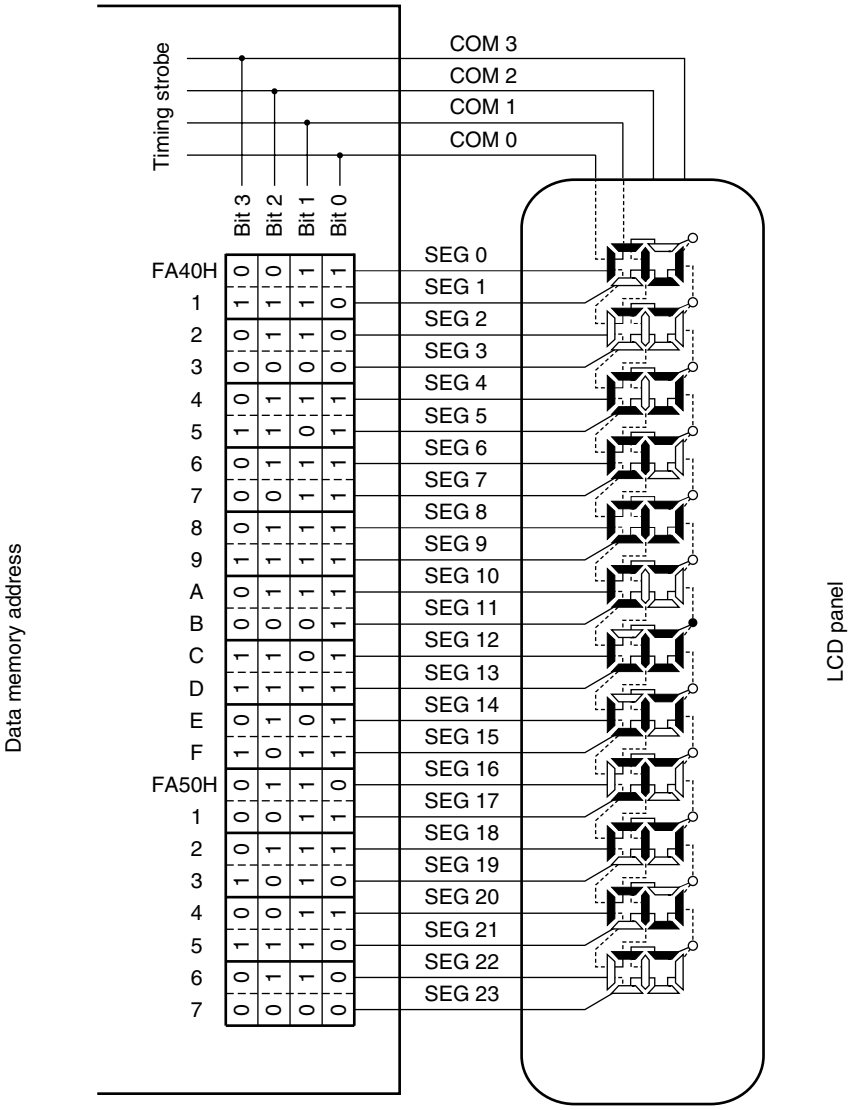
Figures 18-25 and 18-26 show examples of LCD drive waveforms between the SEG6 signal and each common signal in the 1/2 and 1/3 bias methods, respectively. When the select voltage is applied to SEG6 at the timing of COM1 or COM2, an alternate rectangle waveform, $+V_{LCD}/-V_{LCD}$, is generated to turn on the corresponding LCD segment.

Figure 18-23. Three-Time-Slice LCD Display Pattern and Electrode Connections



Remark n = 0 to 7

Figure 18-28. Example of Connecting Four-Time-Slice LCD Panel



19.4.2 Manchester code generator mode

This mode is used to transmit data in Manchester code format using the MCGO pin.

(1) Register description

MCG control register 0 (MC0CTL0), MCG control register 1 (MC0CTL1), and MCG control register 2 (MC0CTL2) are used to set the Manchester code generator mode.

(a) MCG control register 0 (MC0CTL0)

This register can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 10H.

Address: FF4CH After reset: 10H R/W

Symbol	<7>	6	5	<4>	3	2	<1>	<0>
MC0CTL0	MC0PWR	0	0	MC0DIR	0	0	MC0OSL	MC0OLV

MC0PWR	Operation control
0	Operation stopped
1	Operation enabled

MC0DIR	First bit specification
0	MSB
1	LSB

MC0OSL	Data format
0	Manchester code
1	Bit sequential data

MC0OLV	Output level when transmission suspended
0	Low level
1	High level

Caution Clear (0) the MC0PWR bit before rewriting the MC0DIR, MC0OSL, and MC0OLV bits (it is possible to rewrite these bits by an 8-bit memory manipulation instruction at the same time when the MC0PWR bit is set (1)).

Table 21-1. Interrupt Source List (1/2)

Interrupt Type	Default Priority[Note 1]	Interrupt Source		Internal/ External	Vector Table Address	Basic Configuration Type[Note 2]
		Name	Trigger			
Maskable	0	INTLVI	Low-voltage detection[Note 3]	Internal	0004H	(A)
	1	INTP0	Pin input edge detection	External	0006H	(B)
	2	INTP1			0008H	
	3	INTP2			000AH	
	4	INTP3			000CH	
	5	INTP4			000EH	
	6	INTP5			0010H	
	7	INTSRE6	UART6 reception error generation	Internal	0012H	(A)
	8	INTSR6	End of UART6 reception		0014H	
	9	INTST6	End of UART6 transmission		0016H	
	10	INTCSI10/ INTST0	End of CSI10 communication/end of UART0 transmission		0018H	
	11	INTTMH1	Match between TMH1 and CMP01 (when compare register is specified)		001AH	
	12	INTTMH0	Match between TMH0 and CMP00 (when compare register is specified)		001CH	
	13	INTTM50	Match between TM50 and CR50 (when compare register is specified)		001EH	
	14	INTTM000	Match between TM00 and CR000 (when compare register is specified), TI010 pin valid edge detection (when capture register is specified)		0020H	
	15	INTTM010	Match between TM00 and CR010 (when compare register is specified), TI000 pin valid edge detection (when capture register is specified)		0022H	
	16	INTAD[Note 5]	End of 10-bit successive approximation type A/D conversion		0024H	
	17	INTSR0	End of UART0 reception or reception error generation		0026H	
	18	INTRTC	Fixed-cycle signal of real-time counter/alarm match detection		0028H	
	19	INTTM51 [Note 4]	Match between TM51 and CR51 (when compare register is specified)		002AH	
	20	INTKR	Key interrupt detection	External	002CH	(C)
	21	INTRTCI	Interval signal detection of real-time counter	Internal	002EH	(A)

Notes 1. The default priority determines the sequence of processing vectored interrupts if two or more maskable interrupts occur simultaneously. Zero indicates the highest priority and 28 indicates the lowest priority.

2. Basic configuration types (A) to (D) correspond to (A) to (D) in Figure 21-1.

3. When bit 1 (LVIMD) of the low-voltage detection register (LVIM) is cleared to 0.

4. When 8-bit timer/event counter 51 and 8-bit timer H1 are used in the carrier generator mode, an interrupt is generated upon the timing when the INTTM5H1 signal is generated (see **Figure 8-15 Transfer Timing**).

5. μPD78F048x and 78F049x only.

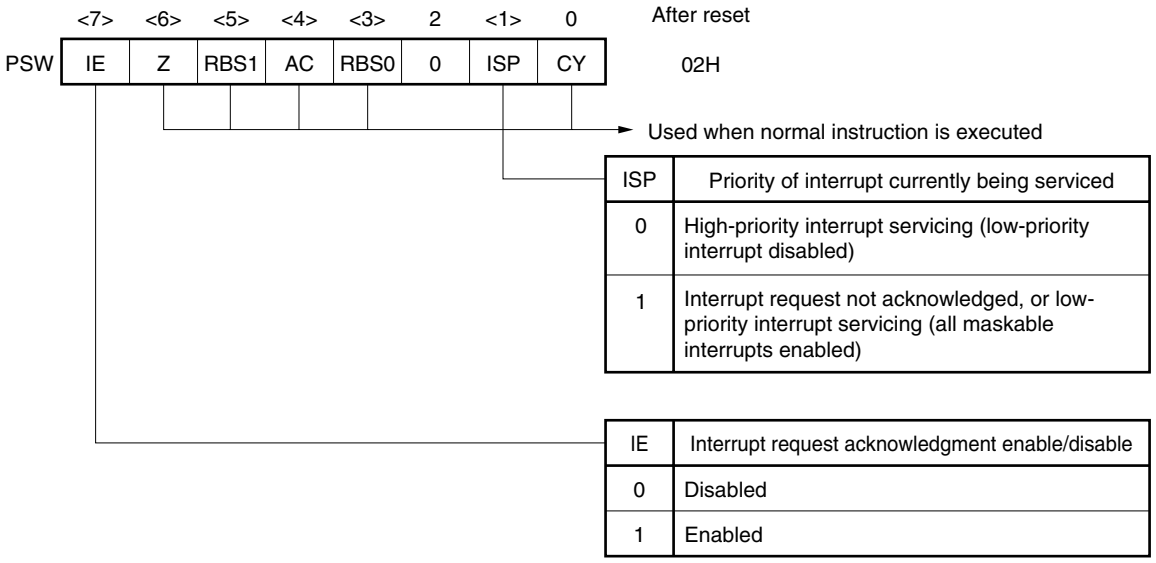
(5) Program status word (PSW)

The program status word is a register used to hold the instruction execution result and the current status for an interrupt request. The IE flag that sets maskable interrupt enable/disable and the ISP flag that controls multiple interrupt servicing are mapped to the PSW.

Besides 8-bit read/write, this register can carry out operations using bit manipulation instructions and dedicated instructions (EI and DI). When a vectored interrupt request is acknowledged, if the BRK instruction is executed, the contents of the PSW are automatically saved into a stack and the IE flag is reset to 0. If a maskable interrupt request is acknowledged, the contents of the priority specification flag of the acknowledged interrupt are transferred to the ISP flag. The PSW contents are also saved into the stack with the PUSH PSW instruction. They are restored from the stack with the RETI, RETB, and POP PSW instructions.

Reset signal generation sets PSW to 02H.

Figure 21-6. Format of Program Status Word



ISP	Priority of interrupt currently being serviced
0	High-priority interrupt servicing (low-priority interrupt disabled)
1	Interrupt request not acknowledged, or low-priority interrupt servicing (all maskable interrupts enabled)

IE	Interrupt request acknowledgment enable/disable
0	Disabled
1	Enabled

CHAPTER 25 POWER-ON-CLEAR CIRCUIT

25.1 Functions of Power-on-Clear Circuit

The power-on-clear circuit (POC) has the following functions.

- Generates internal reset signal at power on.
  In the 1.59 V POC mode (option byte: POCMODE = 0), the reset signal is released when the supply voltage (V_{DD}) exceeds 1.59 V ±0.15 V.
  In the 2.7 V/1.59 V POC mode (option byte: POCMODE = 1), the reset signal is released when the supply voltage (V_{DD}) exceeds 2.7 V ±0.2 V.

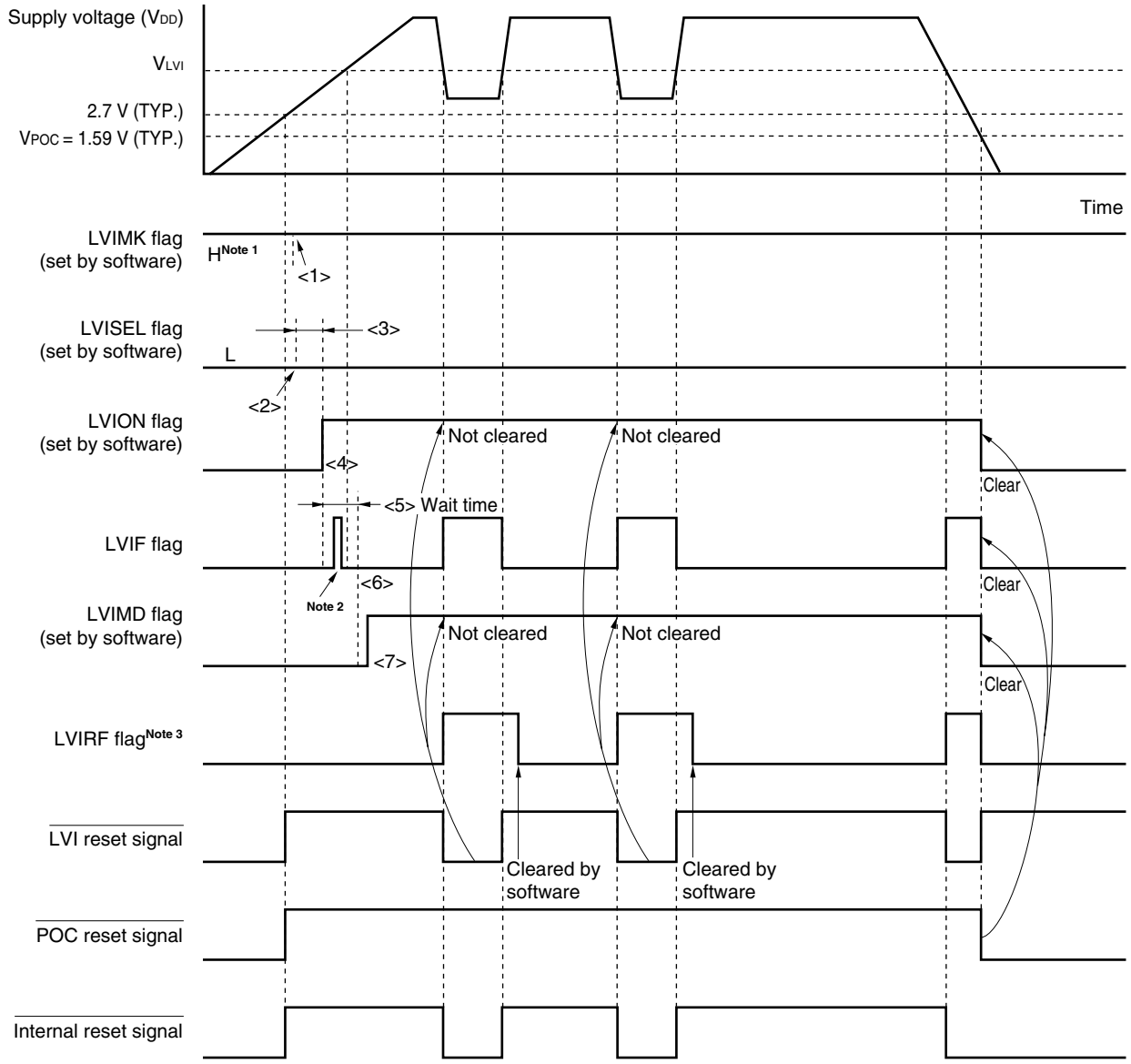
- Compares supply voltage (V_{DD}) and detection voltage (V_{POC} = 1.59 V ±0.15 V), generates internal reset signal when $V_{DD} < V_{POC}$.

Caution If an internal reset signal is generated in the POC circuit, the reset control flag register (RESF) is cleared to 00H.

Remark 78K0/LF3 incorporates multiple hardware functions that generate an internal reset signal. A flag that indicates the reset source is located in the reset control flag register (RESF) for when an internal reset signal is generated by the watchdog timer (WDT) or low-voltage-detector (LVI). RESF is not cleared to 00H and the flag is set to 1 when an internal reset signal is generated by WDT or LVI.
For details of RESF, see **CHAPTER 24 RESET FUNCTION**.

Figure 26-5. Timing of Low-Voltage Detector Internal Reset Signal Generation (Detects Level of Supply Voltage (V_{DD})) (2/2)

(2) In 2.7 V/1.59 V POC mode (option byte: POCMODE = 1)



Notes 1. The LVIMK flag is set to "1" by reset signal generation.

2. The LVIF flag may be set (1).

3. LVIRF is bit 0 of the reset control flag register (RESF). For details of RESF, see **CHAPTER 24 RESET FUNCTION**.

Remark <1> to <7> in Figure 26-5 above correspond to <1> to <7> in the description of "When starting operation" in **26.4.1 (1) When detecting level of supply voltage (V_{DD})**.

<R> **Figure 26-9. Example of Software Processing After Reset Release (2/2)**

• Checking reset source

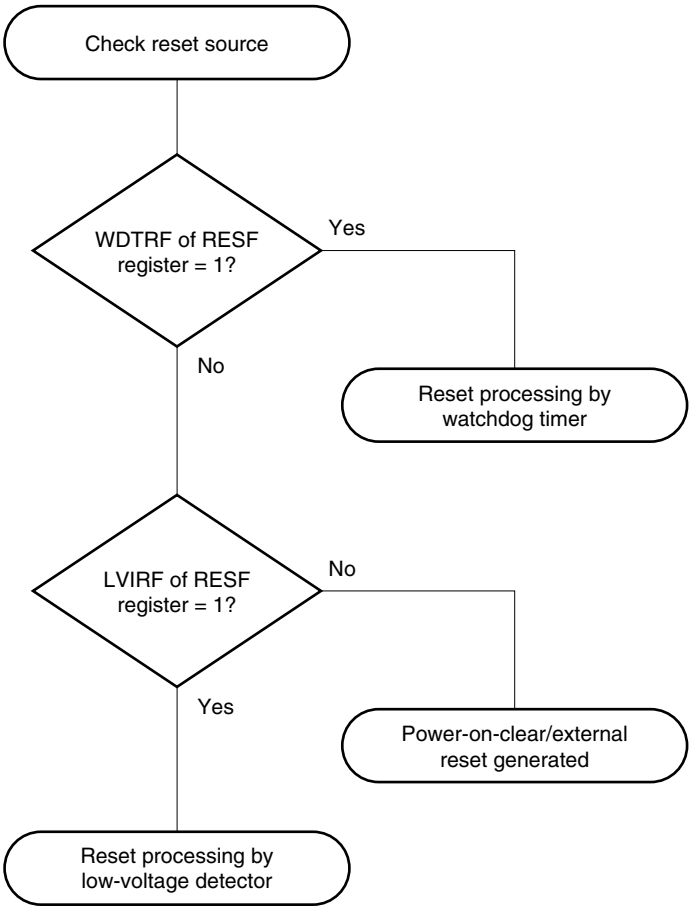
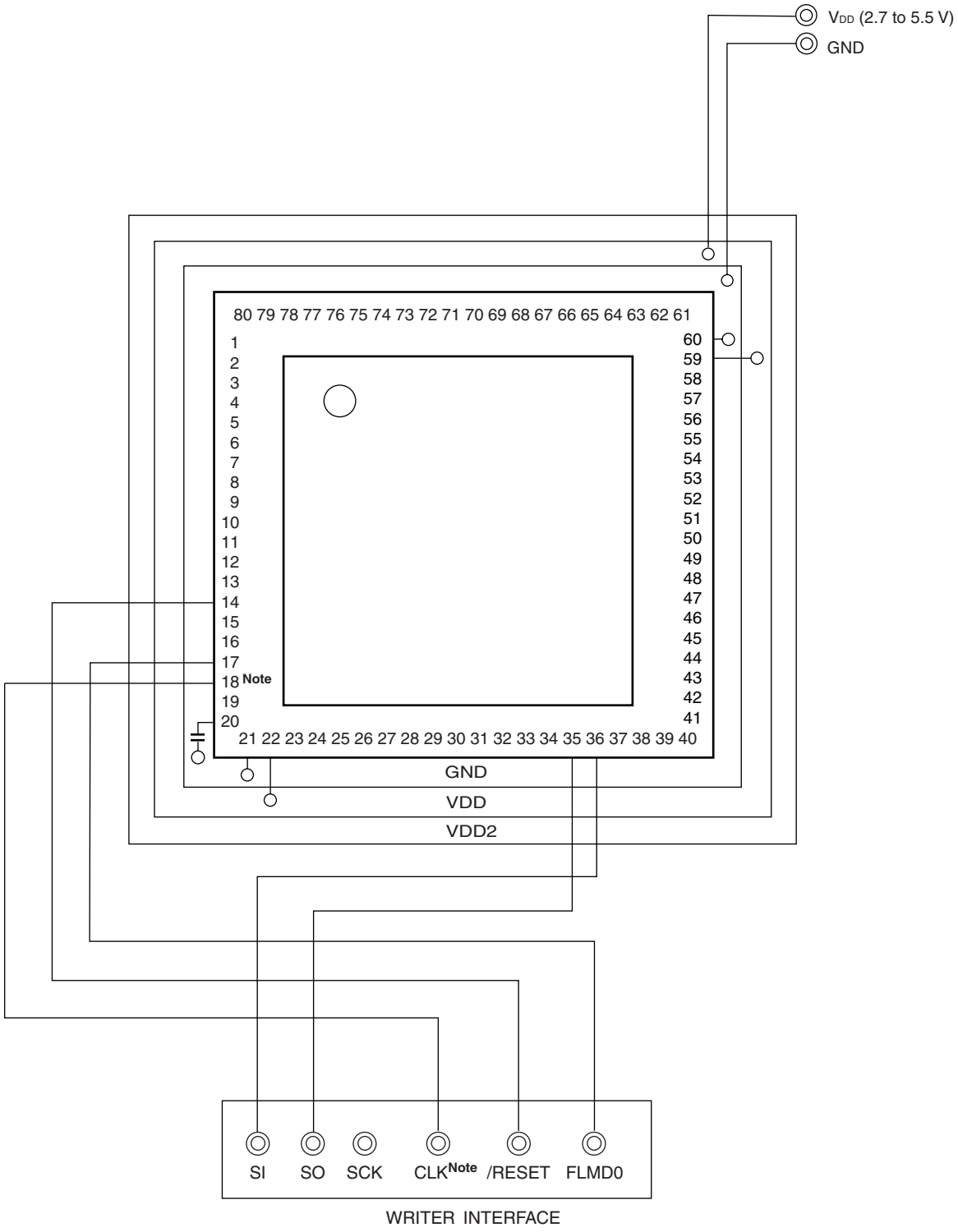


Figure 28-4. Example of Wiring Adapter for Flash Memory Writing in UART (UART6) Mode



Note The above figure illustrates an example of wiring when using the clock output from the PG-FP5 or FL-PR5.